Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

!\ REMINDERS

Product information in this catalog is as of October 2010. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that Taiyo Yuden Co., Ltd. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact Taiyo Yuden Co., Ltd. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance. Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").
 It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that Taiyo Yuden Co., Ltd. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. Taiyo Yuden Co., Ltd. grants no license for such rights.
- Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

WOUND TORROIDS AND BEADS



WAVE

FEATURES

- Use of high loss ferrite materials for excellent high frequency noise absorption.
- High impedance for normal mode applications.
- 05 RD type available in taping for automatic insertion.
- 06 BT type is designed for high current applications (3A).

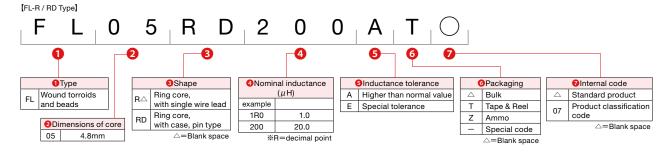
ORDERING CODE

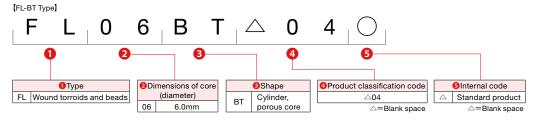
APPLICATIONS

Absorption of high frequency noise from digital equipment data lines.

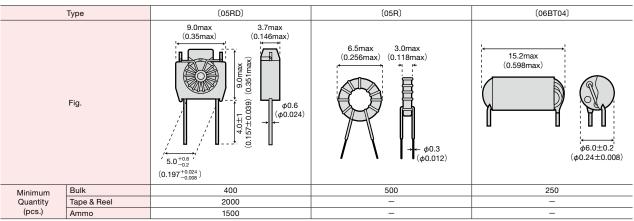
OPERATING TEMP.

−25°C~105°C (Including self-generated heat)



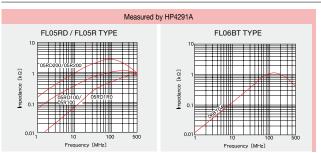


■ EXTERNAL DIMENSIONS/MINIMUM QUANTITY



Unit : mm (inch)

■ IMPEDANCE-FREQUENCY CHARACTERISTICS



Please contact TAIYO YUDEN for further information in regard to other characteristics.

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

Ordering code	EHS	S (Environmental Hazardous Substances)	Inductance [µH]	Impedance (Ω) (typical)	DC Resistance (Ω) (max)	Rated current (A) (max)
FL05RD 1R0E		RoHS	1.0+1.0	800 (at 400MHz)	0.08	0.5
FL05R 100A		RoHS	10 min.	900 (at 200MHz)	0.05	1.5
FL05RD 100A□		RoHS	10 111111.			
FL05R 200A-07		RoHS	20 min.	2000 (at 100MHz)	0.08	1.5
FL05RD 200A		RoHS	Zu Min.	2000 (at 100MHz)	0.08	
FL06BT 04		RoHS	_	1000 (at 150MHz)	0.05	3.0

[☐]Please specify the packaging code (T: Tape & reel, Z: ammo, Blank space: bulk)

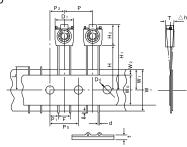
^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

1 Minimum Quantity

Tues	Minimum Quantity (pcs.)					
Type	Bulk	Tape & Reel	Ammo			
FL05R	500	_	_			
FL05RD	400	2000	1500			
FL06BT	250	_	_			

2Taping dimensions

FL05RD



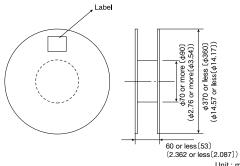
Туре	Symbol	Dimension
	D ₁	9.0 max. (0.354 max.)
	H ₂	9.0 max. (0.354 max.)
	T	3.7 max. (0.146 max.)
	H ₁	31.0 max. (1.22 max.)
	Н	18.0±1.0 (0.709±0.039)
	Р	12.7±1.0 (0.500±0.039)
	P ₀	12.7±0.3 (0.500±0.012) **1
	P ₁	3.85±0.8 (0.152±0.031)
	P ₂	6.35±1.3 (0.250±0.051)
FLOFED	W ₁	$9.0^{+0.75}_{-0.5}$ (0.354 $^{+0.030}_{-0.020}$)
FL05RD	F	$5.0^{+0.6}_{-0.2}$ (0.197 $^{+0.024}_{-0.008}$)
	d	φ0.6 (φ0.024)
	△h	0±2.0 (0±0.079)
	W	18.0 ^{+1.0} _{-0.5} (0.709 ^{+0.024} _{-0.008})
	W _o	12.5 min. (0.492 min.)
	W ₂	3.0 min. (0.118 min.) **2
	l	0 max. (0 max.)
	D ₀	4.0±0.3 (0.157±0.012)
	L	11.0 max. (0.433 max.)
	t	0.7±0.2 (0.028±0.008)

^{*1} Accumulated error for 20 pitches shall be within ±2mm. ※2 Pasting tape shall not exceed paste board.

Unit: mm (inch)

3 Reel size

FL05RD



Dimensions in parenthesis are measured value.

Unit: mm (inch)

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

R	F	П	Δ	R	Ш	IT'	V	\Box	Δ٦	ΓΔ

Operating temperature Range							
·							
LA Type	0.5 1/05/20						
CAL45 Type	_25~+105°C						
LHL BR							
FL05 Type	-25°+65C						
	.06BT Type						
Test Method and Remarks							
LA·CA·FL: Including self-generated he	eat .						
LHL : Including self-generated he	eat						
2. Storage temperature Range							
LA Type							
CAL45 Type							
LHL							
FBA/FBR	-40~+85°C						
FL05 Type							
FL06BT Type							
O. Data de consul							
3. Rated current							
LA Type CAL45 Type							
LHL							
FBA/FBR	Within the specified tolerance						
FL05 Type							
FL06BT Type							
[Test Method and Remarks]							
	ving inductance within 10% and temperature incease within 40°C (LA:20°C) by the application of DC bias.						
LHL : The maximum DC value hat temperature by the application	ving inductance decrease within 10% (LHLC08, LHLC10: within 30%) and temperature increase within the following specified						
	utori of DC bias. 5°C (LHL08, LHL10, LHL13)						
: 3	30°C (LHL16, LHLP□□)						
	10°C (LHLC08, LHLC10)						
	arance abnormality by continuous current application for 30 min. Change after the application shall be within $\pm 20\%$ of the initial value.						
	wing temperature rise within specified value.						
A law advance							
4. Impedance LA Type							
CAL45 Type							
LHL							
FBA/FBR	Within the specified tolerance						
FL05 Type	The speciment contains						
FL06BT Type	Refer to individual specification						
[Test Method and Remarks]							
Test wethout and remarks: Second of the property of the pro							
	Measuring frequency : Specified frequency						
Measuring frequency : Spec	4 (HP) or its equivalent						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec							
Measuring frequency : Spec FL06BT : Measuring equipment : 4291 Measuring frequency : Spec 5. Inductance							
Measuring frequency : Spec FL06BT : Measuring equipment : 4291 Measuring frequency : Spec 5. Inductance LA Type	ified frequency						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291, Measuring frequency : Spec 5. Inductance LA Type CAL45 Type							
Measuring frequency : Spec FL06BT : Measuring equipment : 4291 Measuring frequency : Spec 5. Inductance LA Type	ified frequency						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291 Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL	ified frequency						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL	Within the specified tolerance						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291 Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL FBA/FBR FL05C Type FL06BT Type [Test Method and Remarks]	Within the specified tolerance Within the specified tolerance						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL	Within the specified tolerance Within the specified tolerance Within the specified tolerance CR meter (HP4285A + HP42851A or its equivalent)						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291 Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL______ FBA/FBR FL05__\Type FL06BT Type [Test Method and Remarks] LA, CA : Measuring equipment : L4 Measuring frequency : S	Within the specified tolerance Within the specified tolerance Within the specified tolerance CR meter (HP4285A + HP42851A or its equivalent) pecified frequency						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL	Within the specified tolerance Within the specified tolerance Within the specified tolerance CR meter (HP4285A + HP42851A or its equivalent)						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL FBA/FBR FL05 Type FL06BT Type [Test Method and Remarks] LA, CA : Measuring equipment : L4	Within the specified tolerance Within the specified tolerance Within the specified tolerance OR meter (HP4285A + HP42851A or its equivalent) pecified frequency OR meter (HP4285A+HP42851A or its equivalent) OR meter (HP4263A) or its equivalent (at 1KHz) pecified frequency						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291 Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL	Within the specified tolerance Within the specified tolerance Within the specified tolerance OR meter (HP4285A + HP42851A or its equivalent) pecified frequency OR meter (HP4285A+HP42851A or its equivalent) OR meter (HP4285A) or its equivalent (at 1KHz) pecified frequency P4262A or its equivalent						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL FBA/FBR FL05 Type FL06BT Type [Test Method and Remarks] LA, CA : Measuring equipment : L4	Within the specified tolerance Within the specified tolerance Within the specified tolerance OR meter (HP4285A + HP42851A or its equivalent) pecified frequency OR meter (HP4285A+HP42851A or its equivalent) OR meter (HP4285A) or its equivalent (at 1KHz) pecified frequency P4262A or its equivalent						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL FBA/FBR FL05 Type FL06BT Type [Test Method and Remarks] LA, CA : Measuring equipment : L4 Measuring frequency : S LHL Measuring frequency : S FL05R : Measuring equipment : L4 Measuring frequency : S FL05R : Measuring frequency : S FL05R : Measuring frequency : S FL05R : Measuring frequency : S FL05R	Within the specified tolerance Within the specified tolerance Within the specified tolerance CR meter (HP4285A + HP42851A or its equivalent) pecified frequency CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A) or its equivalent (at 1KHz) pecified frequency P4262A or its equivalent (at 1KHz)						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291 Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL	Within the specified tolerance Within the specified tolerance Within the specified tolerance OR meter (HP4285A + HP42851A or its equivalent) pecified frequency OR meter (HP4285A+HP42851A or its equivalent) OR meter (HP4285A) or its equivalent (at 1KHz) pecified frequency P4262A or its equivalent						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291 Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL	Within the specified tolerance Within the specified tolerance Within the specified tolerance CR meter (HP4285A + HP42851A or its equivalent) pecified frequency CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A) or its equivalent (at 1KHz) pecified frequency P4262A or its equivalent (at 1KHz)						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL	Within the specified tolerance Within the specified tolerance Within the specified tolerance CR meter (HP4285A + HP42851A or its equivalent) pecified frequency CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A) or its equivalent (at 1KHz) pecified frequency P4262A or its equivalent (at 1KHz)						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL	Within the specified tolerance Within the specified tolerance Within the specified tolerance CR meter (HP4285A + HP42851A or its equivalent) pecified frequency CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A) or its equivalent (at 1KHz) pecified frequency P4262A or its equivalent (at 1KHz)						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL	Within the specified tolerance Within the specified tolerance Within the specified tolerance CR meter (HP4285A + HP42851A or its equivalent) pecified frequency CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A) or its equivalent (at 1KHz) pecified frequency P4262A or its equivalent (at 1KHz)						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL FBA/FBR FL05 Type FL06BT Type [Test Method and Remarks] LA, CA : Measuring equipment : L4 Measuring frequency : S LHL Measuring frequency : S SHOSR : Measuring equipment : L4 Measuring frequency : S FL05R : Measuring equipment : L4 Measuring frequency : S FL05R : Measuring equipment : L4 Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S FL05R : Measuring equipment : H Measuring frequency : S	Within the specified tolerance Within the specified tolerance Within the specified tolerance CR meter (HP4285A + HP42851A or its equivalent) pecified frequency CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A) or its equivalent (at 1KHz) pecified frequency P4262A or its equivalent (at 1KHz)						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL	Within the specified tolerance Within the specified tolerance Within the specified tolerance CR meter (HP4285A + HP42851A or its equivalent) pecified frequency CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A+HP42851A or its equivalent) CR meter (HP4285A) or its equivalent (at 1KHz) pecified frequency P4262A or its equivalent (at 1KHz)						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL FBA/FBR FL05 Type [Test Method and Remarks] LA, CA : Measuring equipment : L4 Measuring frequency : S LHL Measuring frequency : S SECOND : Measuring equipment : L4 Measuring frequency : S FL05R : Measuring equipment : L4 Measuring frequency : S FL05R : Measuring equipment : L4 Measuring frequency : S FL05R : Measuring equipment : L4 Measuring frequency : S FL05R : Measuring equipment : L6 Measuring frequency : S FL05R : Measuring equipment : L7 Measuring frequency : S FL05R : Measuring equipment : L7 SECOND : S SECOND	Within the specified tolerance Within the specified tolerance Within the specified tolerance OR meter (HP4285A + HP42851A or its equivalent) pecified frequency OR meter (HP4285A+HP42851A or its equivalent) OR meter (HP4263A) or its equivalent (at 1KHz) pecified frequency P4262A or its equivalent (at 1KHz) Within the specified tolerance Within the specified tolerance						
Measuring frequency : Spec FL06BT : Measuring equipment : 4291/ Measuring frequency : Spec 5. Inductance LA Type CAL45 Type LHL____\ FBA/FBR FL05__Type [Test Method and Remarks] LA, CA : Measuring equipment : L4 Measuring frequency : S LHL____\: Measuring equipment : L4 Measuring frequency : S LHCSR__: Measuring equipment : L4 Measuring frequency : S FL05R__: Measuring equipment : L4 Measuring frequency : S FL05R__: Measuring equipment : H Measuring frequency : II 6. Q LA Type CAL45 Type LHL_____ FBA/FBR FL05__Type FL06BT Type [Test Method and Remarks] LA : Measuring equipment : LCR mete Measuring frequency : Specified	Within the specified tolerance Within the specified tolerance Within the specified tolerance CR meter (HP4285A + HP42851A or its equivalent) pecified frequency CR meter (HP4263A+HP42851A or its equivalent) CR meter (HP4263A) or its equivalent (at 1KHz) pecified frequency P4262A or its equivalent (at 1KHz) Within the specified tolerance Within the specified tolerance						

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

RELIAB	ILITY D	DATA						
7. DC Resisit	ance							
LA Type								
CAL45 Type								
LHL								
FBA/FBR			Within the specified tolerance					
FL05 Type								
FL06BT Type								
Test Method	and Rema	uipment : low oh	nmmeter (A&D AD5812 or its equivalent) ent:DC ohmmeter					
8. Self resona	ance frequ	iencv						
LA Type	anoo noqo		Within the specified tolerance					
CAL45 Type			The specime to salarie					
LHL								
FBA/FBR								
FL05 Type								
FL06BT Type								
Test Method LA: Measuri	and Rema	nent : Network ar	nalyzer (Anritsu MS620J or its equivalent) quipment : (HP4191A, 4192A) its equivalent					
9. Temperatu	ire charact	teristic						
LA Type			△L/L: Within ±5%					
CAL45 Type								
LHL			△L/L: Within ±7% (except LHLP16: Within ±20%)					
FBA/FBR								
FL05 Type								
FL06BT Type								
Test Method			eviation in step 1 to 5					
г у.			·					
	Step 1	Terr	nperature (°C)					
-	2	OF (Minimum	·					
-	3		n operating temperature)					
+	4	,	dard temperature)					
-	5	±85 (Maximum	n operating temperature)					
L	5		20					
ן ן ן ן	Temperatu Temperatu Temperatu Temperatu	re at step 1 : 20 re at step 2 : Mi re at step 3 : 20	inimum operating temperature °C (Standard temperature) aximum operating temperature					
10 Topoils of	ronath too	.+						
10. Tensile st	rengin tes	o L						
LA Type			4					

CAL45 Type	
LHL 🗆 🗆 🗆	

No abnormality such as cut lead, or looseness.

FBA/FBR No abnormality such as cut lead, or looseness. FL05 Type No abnormality such as cut lead, or looseness. FL06BT Type

[Test Method and Remarks]

: Apply the stated tensile force progressively in the direction to draw terminal. LA

force (N)	duration (s)		
25	5		

: $\underline{\mbox{Apply the stated tensile force progressively in the direction to draw terminal.}$ CA

force (N)	duration (s)
10	10

 $\textbf{LHL} \square \square \square : \underline{\textbf{Apply the stated tensile force progressively in the direction to draw terminal.}$

Nominal wire diameter tensile ϕ d (mm)	force (N)	duration (s)
0.3<¢d≦0.5	5	
0.5<φd≦0.8	10	30±5
0.8<¢d≦1.2	25	

FBA/FBR : The body of a component shall be fixed and a tensile force of 20±1N shall be applied to the lead wire in the axial diretion of the component during 10±1 seconds. FL05R : Fix the body of a component in the direction to draw terminal, and gradually apply the tensile force of 4.9N.

11. Over current					
LA Type	No antistica of analysis of fision				
CAL45 Type	No emission of smoke no firing.				
	There shall be no scorch or short of wire. LHLC08,LHLC10:There shall be no firing.				
FBA/FBR					
FL05□ Type					
FL06BT Type					
[Test Method and Remarks]					
LHL . / LA. CAL45 Type: Measuring					
Duration	: 5 min.				
Number of	measuring : one time				

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

■ KEL	■ RELIABILITY DATA						
12. Terminal strength: bending							
LA Type							
CAL45 Ty	/ре	Nia abac					
LHL		NO abnormality such	as cut lead, or looseness				
FBA/FBF							
FL05 T							
FL06BT							
	thod and Remarks						
	is done over a period of 2-3 second			e body through the angle of 90 degrees and return it to the initial position. This operation			
	Number of bends : Two times.	5. Then second bend i	ir the opposite direction s	mail be made.			
	Nominal wire diameter tensile	Bending force	Mass reference weight				
	φd (mm)	(N)	(kg)				
	0.3<¢d≦0.5	2.5	0.25				
==	0.5<φd≦0.8	5	0.50				
	is done over a period of 2-3 sec			e body through the angle of 90 degrees and return it to the initial position. This operation			
	Number of bends : Two times.	s. Their second bend i	The opposite direction of	mail be made.			
	Nominal wire diameter tensile		Mass reference weight				
	φd (mm)	(N)	(kg)				
	0.3<φd≦0.5	2.5	0.25				
	0.5<φd≦0.8 0.8<φd≦1.2	5 10	0.5 1.0				
	0.6√φd≦1.2	10	1.0				
	ation resisitance : between the	terminals and body					
LA Type							
CAL45 Ty		100MO:					
FBA/FBF		100MΩ min.					
FL05 T							
FL06BT							
	thod and Remarks	<u> </u>					
	: Applied voltage: 500 VDC						
	Duration : 60 sec.						
14. Insul	ation resistance : between ter	minals and core					
LA Type	301.101.11011						
CAL45 Ty	/ре						
LHL							
FBA/FBF		1MΩ min. (Other than	materail code MA)				
FL05 T	ype						
FL06BT			·				
	thod and Remarks						
-BA•FBF	R: Applied voltage: 100 VDC Duration: 60±5 sec	t.					
	standing: between the termina	als and body					
LA Type							
CAL45 Ty							
LHL [No abnormality such	as insulation damage				
FBA/FBF							
FL05 T							
FL06BT 1	thod and Remarks	<u> </u>					
LHL	$_$: Accoding to JIS C5102. 7. 1	. 3 (C)					
	Metal global method						
	Applied voltage: 500 VDC Duration: 60 sec.	•					
	ias characteristic						
LA Type		△L/L : Within -10%					
CAL45 Ty	-						
LHL [
FBA/FBF							
FL05 T							
	thod and Remarks	1					
	Measure inductance with appli	ation of rated current	using LCR meter to comp	pare it with the initial value.			
	/ strength						
LA Type	·no	No abnormality as da	mage.				
CAL45 Ty							
FBA/FBF		No abnormality such	as cracks on hody				
FL05 T		abnormality such	ac cracke on body.				
FL06BT							
	thod and Remarks]	i					
LA :	Applied force : 30N						
	Duration : 10 sec.						
	Speed : Shall attain to specified force in 2 sec. Press Pressing jig						
	CAL45 : Applied force : 50N						
	Duration : 10 sec. Speed : Shall attain to specified force in 2 sec. Specimen						
	Speed : Shall attain to specified force in 2 sec.						
	Applied force : 50±3N			← →!			
	Duration : 30±1 sec. 1mm 1mm						

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

LA Type	tance to vibration	
		△L/L : Within ±5% Q:30min
CAL45 Typ	ре	△L/L: Within ±5%
LHL		Appearance: No abnomality $\triangle L/L$: Within $\pm 5\%$ Q change: Within $\pm 30\%$ (LHLP: only $\triangle L/L$)
FBA/FBR		Appearance: No abnomality Impedance change: Within ±20%
FL05 Typ	ре	
FL06BT Ty	ре	
	nod and Remarks	
LA, CA	Amplitude Mounting method Recovery	: 2 hrs each in X, Y and Z directions total : 6hrs. : 10 to 55 to 10Hz (1min.) : 1.5mm d : Soldering onto printed board. : At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs.
LHL	Amplitude	: 2 hrs each in X, Y and Z directions total : 6hrs. : 10 to 55 to 10Hz (1min.) : 1.5mm (But don't exceed acceleration 196m/s² (two power)) d : Soldering onto printed board.
19 Resist	ance to shock	
LA Type	ande to shook	
CAL45 Typ	ne	No significant abnormality in appearance
FBA/FBR	1	
FL05 Typ	20	
FL05⊟ Typ FL06BT Ty		
Test Meth LA, CA Impa Heigh Total	ood and Remarks] : Drop tes ct material : concrete o nt : 1m number of drops : 10 ti	r vinyl tile
20. Solder	rability	
LA Type		At least 75% of terminal electrode is covered by new solder.
CAL45 Typ		·
LHL		At least 75% of terminal electrode is covered by new solder.
FBA/FBR		At least 90% of terminal electrode is covered by new solder.
FL05 Typ		At least 75% of terminal electrode is covered by new solder.
FL06BT Ty	pe nod and Remarks	A sact 10% of terminal section 5, non-section
	Duration :	
LHL 🗆 🗆 🗆		: 2±0.5 sec. : 235±5°C : 2±0.5 sec. : Up to 1.5mm from bottom of case.
	Duration : Immersion depth : Solder temperature : Duration :	: 235±5°C : 2±0.5 sec. : Up to 1.5mm from bottom of case. : 230±5°C : 3±1 sec.
FB	Duration : Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration :	: 235±5°C : 2±0.5 sec. : Up to 1.5mm from bottom of case. : 230±5°C : 3±1 sec. : Up to 1.5mm from terminal root. : 230±5°C : 2±0.5 sec.
FB FL05R□	Duration Immersion depth : Solder temperature : Duration Immersion depth : Solder temperature : Duration Immersion depth : Solder temperature : Duration Duration Immersion depth :	: 235±5°C : 2±0.5 sec. : Up to 1.5mm from bottom of case. : 230±5°C : 3±1 sec. : Up to 1.5mm from terminal root. : 230±5°C : 2±0.5 sec. : Up to 2 to 2.5mm from terminal root. : 230±5°C : 3±1 sec.
FB FL05R□ FL06BT	Duration Immersion depth : Solder temperature Duration Immersion depth : Solder temperature Duration Immersion depth : Solder temperature Duration Immersion depth :	235±5°C 2±0.5 sec. 1 Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. 1 Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. 1 Up to 2 to 2.5mm from terminal root.
FL05R□ FL06BT 21. Resisit	Duration Immersion depth : Solder temperature : Duration Immersion depth : Solder temperature : Duration Immersion depth : Solder temperature : Duration Duration Immersion depth :	235±5°C 2±0.5 sec. Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root.
FL05R□ FL06BT 21. Resisit	Duration Immersion depth : Solder temperature Duration Immersion depth : Solder temperature : Duration Immersion depth : Solder temperature : Duration Immersion depth : Market Solder temperature : Duration Immersion depth : Lance to soldering heat	235±5°C 2±0.5 sec. Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root.
FL05R FL06BT 21. Resisit LA Type CAL45 Typ	Duration Immersion depth : : Solder temperature : Duration Immersion depth : : Solder temperature : Duration Immersion depth : : Solder temperature : Duration Immersion depth : tance to soldering heat	235±5°C 2±0.5 sec. Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root.
FL05RC FL06BT 21. Resisit LA Type CAL45 Typ LHL	Duration Immersion depth : : Solder temperature : Duration Immersion depth : : Solder temperature : Duration Immersion depth : : Solder temperature : Duration Immersion depth : tance to soldering heat	235±5°C 2±0.5 sec. Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 5 to 1.0mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root.
FL05R FL06BT 21. Resisit LA Type CAL45 Typ LHL	Duration Immersion depth : : Solder temperature : Duration Immersion depth : : Solder temperature : Duration Immersion depth : : Solder temperature : Duration Immersion depth : tance to soldering heat	235±5°C 2±0.5 sec. Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±6°C 3±1 sec. Up to 2 to 2.5mm from terminal root. 230±6°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L: Within ±5% No significant abnormality in appearance Inductance change: Within ±5% Q change: Within ±30%(LHLP: only △L/L) No significant abnormality in appearance Impedance change: Within ±20%
FL05R 21. Resisit LA Type CAL45 Typ LHL 21. FBA/FBR FL05 Typ	Duration Immersion depth : Solder temperature : Duration Immersion depth : Solder temperature : Duration Immersion depth : Solder temperature : Duration Immersion depth : Tance to soldering heat	235±5°C 2±0.5 sec. Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L: Within ±5% No significant abnormality in appearance Inductance change: Within ±5% No significant abnormality in appearance Impedance change: Within ±20% Refer to individual specification
FL05R FL06BT 21. Resisit A Type CAL45 Typ FBA/FBR FL05 Tyg FL06BT Ty	Duration Immersion depth : Solder temperature : Duration Immersion depth : Solder temperature : Duration Immersion depth : Solder temperature : Duration Immersion depth : tance to soldering heat temperature to soldering heat temperature to soldering heat temperature	235±5°C 2±0.5 sec. Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance ΔL/L: Within ±5% No significant abnormality in appearance Inductance change: Within ±5% Q change: Within ±30%(LHLP: only ΔL/L Impedance change: Within ±20%
FL05R 21. Resisii LA Type CAL45 Typ LHL FBA/FBA FBL05E Typ FL06BT Ty Test Meth	Duration	235±5°C 2±0.5 sec. Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±6°C 3±1 sec. Up to 2 to 2.5mm from terminal root. 230±6°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L: Within ±5% No significant abnormality in appearance Inductance change: Within ±5% Q change: Within ±30%(LHLP: only △L/L No significant abnormality in appearance Refer to individual specification
FL05R 21. Resisit A Type CAL45 Typ HL0 7 Type FL06BT Ty FL06BT Ty Test Meth A, CA	Duration Duration Immersion depth Solder temperature Duration Immersion depth Solder temperature Duration Immersion depth Solder temperature Duration Immersion depth Color temperature Duration Immersion depth Solder temperature Duration Immersion depth Duration Solder temperature Duration Solder temperature Duration Immersed conditions Recovery	235±5°C 2±0.5 sec. Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance ΔL/L: Within ±5% No significant abnormality in appearance Inductance change: Within ±5% Q change: Within ±30%(LHLP: only ΔL/L No significant abnormality in appearance Impedance change: Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change: Within ±20% 2 (CA) 270±5°C, (LA) 260±5°C 2 ±0.5 sec. One time 1 Inserted into substrate with t=1.6mm 1 At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs. 2 Solder temperature: 260±5°C Duration: 10±1 sec.
FL05R 21. Resisit LA Type CAL45 Typ LHL FBA/FBR FL05 Tyg FL06BT Ty [Test Meth LA, CA	Duration Duration Immersion depth Solder temperature Duration Immersion depth Solder temperature Duration Immersion depth Solder temperature Duration Immersion depth Color temperature Duration Immersion depth Solder temperature Duration Immersion depth Duration Solder temperature Duration Solder temperature Duration Immersed conditions Recovery	235±5°C 2±0.5 sec. Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L: Within ±5% No significant abnormality in appearance Inductance change: Within ±5% Q change: Within ±30%(LHLP: only △L/L No significant abnormality in appearance Impedance change: Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change: Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change: Within ±20% 1 (CA) 270±5°C, (LA) 260±5°C 1 5±0.5 sec. Up to 2 to 2.5mm from terminal root. 2 (CA) 270±5°C, (LA) 260±5°C 2 to 5±0.5 sec. Up to 2 to 2.5mm from terminal root. 2 to 2 t
FL05R 21. Resisit LA Type CAL45 Typ LHL FBA/FBR FL05 Tyg FL06BT Ty [Test Meth LA, CA	Duration Immersion depth : Solder temperature : Duration Immersion depth : Solder temperature : Duration Immersion depth : Solder temperature : Duration Immersion depth : tance to soldering heat temperature to solder depth : Solder temperature : Duration Immersion depth : Solder temperature : Duration Immersion depth : Solder temperature : Duration Immersed conditions Recovery : Solder bath method	235±5°C 2±0.5 sec. Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance ΔL/L: Within ±5% No significant abnormality in appearance Inductance change: Within ±5% Q change: Within ±30%(LHLP: only ΔL/L No significant abnormality in appearance Impedance change: Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change: Within ±20% (CA) 270±5°C, (LA) 260±5°C 5±0.5 sec. One time Inserted into substrate with t=1.6mm At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs. Solder temperature: 260±5°C Duration: 10±1 sec. Up to 1.5mm from the bottom of case. Solder temperature: 350±10°C (At the tip of soldering iron) Duration: 5±1 sec.
FL05R 21. Resisification of the state of the	Duration Immersion depth Solder temperature Duration Solder temperature Duration Immersed conditions Recovery Solder bath method Manual soldering Caution Recovery Caution Caution Recovery Caution Cautio	235±5°C 2±0.5 sec. Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. Up to 1.5mm from terminal root. 230±5°C 3±2.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 1.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L: Within ±5% No significant abnormality in appearance Inductance change: Within ±5% Q change: Within ±30%(LHLP: only △L/L No significant abnormality in appearance Impedance change: Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change: Within ±20% (CA) 270±5°C, (LA) 260±5°C 5±0.5 sec. One time : Inserted into substrate with t=1.6mm : At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs. Solder temperature: 260±5°C Duration Up to 1.5mm from the bottom of case. : Solder temperature: 280±10°C (At the tip of soldering iron) Duration: 5±1 sec. Up to 1.5mm from the bottom of case. : No excessive pressing shall be applied to terminals. : 4 to 24hrs of recovery under the standard condition after the test. : Condition 1: Solder temperature: 280±5°C Duration: 10±1 sec. Up to 1.5mm from the bottom of case. : Condition 1: Solder temperature: 280±5°C Duration: 10±1 sec. Up to 1.5mm from the terminal root. Condition 2: Solder temperature: 250±5°C Duration: 10±1 sec. Up to 1.5mm from the terminal root. Condition 2: Solder temperature: 250±5°C Duration: 10±1 sec. Up to 1.5mm from the terminal root. Condition 2: Solder temperature: 250±5°C Duration: 10±1 sec. Up to 1.5mm from the terminal root. Condition 2: Solder temperature: 250±5°C
FL05R FL06BT 21. Resisit LA Type CAL45 Typ LHL FBA/FBR FL05 Tyg FL06BT Ty [Test Meth LA, CA	Duration Immersion depth Solder temperature Duration Solder temperature Duration Immersed conditions Recovery Solder bath method Manual soldering Caution Recovery Caution Caution Recovery Caution Cautio	235±5°C 2±0.5 sec. Up to 1.5mm from bottom of case. 230±5°C 3±1 sec. Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 1.5 to 1.0mm from terminal root. No significant abnormality in appearance

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

22. Resisitance to solvent						
LA Type						
CAL45 Type	Please avoid the ultrasonic cleaning of this product.					
LHL						
FBA/FBR	No significant abnormality in appearance					
FL05 Type						
FL06BT Type						
Test Method and Remarks FB: Solvent temperature: 20~25°C Duration: 30±5 sec.						
	chloroethylene					
	very under the standard condition after the test.					
23. Thermal shock						
LA Type	△L/L: Within ±10% Q:30min					
CAL45 Type	△L/L: Within ±10%					
LHL	Appearance : No abnormality					
FBA/FBR	Appearance : No abnormality					
FL05 Type	Refer to individual specification					
FL06BT Type	Appearance : No abnormality					
[Test Method and Remarks]						

LA, CA : Conditions for 1cycle

Step	Temperature (℃)	Duration (min.)
1	-25 ⁺⁰ ₋₃	30±3
2	Room temperature	Within 3
3	+85 ⁺²	30±3
4	Room temperature	Within 3

Number of cycles : 5 cycles

Recovery : At least 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs.

LHL : FB : Accoding to JIS C0025 Conditions for 1 cycle

Step	Temperature (°C)	Duration (min.)
1	Minimum operating temperature ⁺⁰ ₋₃	30±3
2	Room temperature	Within 3
3	Minimum operating temperature ⁺² ₋₀	30±3
4	Room temperature	Within 3

Number of cycles : 10 cycles (LHL

: 5 cycles (FBA, FBR) : 4 to 24hrs of recovery under the standard condition after the removal from the test chamber. (LHL Recovery

: 3hrs of recovery under the standard condition after the removal from the test chamber. (FBA, FBR)

FL : Accoding to JIS C0025 Conditions for 1 cycle

Step	Temperature (°C)	Duration (min.)
1	-25^{+0}_{-3}	30±3
2	Room temperature	Within 3
3	+85 ⁺²	30±3
4	Room temperature	Within 3

Number of cycles: 10 cycles

: 1 to 2hrs of recovery under the standard condition after the removal from the test chamber. Recovery

24. Damp heat		
LA Type	△L/L: Within ±10% Q:30min	
CAL45 Type	△L/L : Within ±10%	
LHL		
FBA/FBR	Appearance : No abnormality	Impedance change: Within ±20%
FL05□ Type		
FL06BT Type		

[Test Method and Remarks] LA, CA: Temperature: 40±2°C
Humidity: 90~95%RH Humidity Duration

Recovery $: At \ least \ 1hr \ of \ recovery \ under \ the \ standard \ removal \ from \ test \ chamber, followed \ by \ the \ measurement \ within \ 2hrs.$

FB : Temperature : $60\pm2^{\circ}C$ 90~95%RH Humidity Duration

1 to 2hrs of recovery under the standard condition after the removal from the test chamber. Recovery

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

RELIABILITY DATA						
25 Loadin	g under damp heat					
LA Type \triangle L/L : Within ±10% Q : 30min						
CAL45 Type	ie.	△L/L : Within ±10%				
LHL		Appearance : No abnormality				
FBA/FBR						
FL05 Typ	ne .	Refer to individual specification				
FL06BT Typ		Appearance : No abnormality				
	od and Remarks)				
	: Temperature : 40±2°C Humidity : 90~95% Duration : 1000 hrs Applied current : Rated cu					
LHL	: Temperature : 40±2°C Humidity : 90~95% Duration : 1000±20 Applied current : Rated cu Recovery : 1 to 2hrs	4 hrs				
FL	: Temperature : 60±3°C Humidity : 90~95% Duration : 500 (+12 Applied current : Rated cu Recovery : 1 to 2hrs	2, —0) hrs				
26. Loadin	ig at high temperature					
LA Type	J	△L/L : Within ±10% Q:30min				
CAL45 Type	e	△L/L: Within ±10%				
LHL						
FBA/FBR						
FL05 Typ	oe .					
FL06BT Typ						
	: Temperature : 85±2°C Duration : 1000 hrs Applied current : Rated cu Recovery : At least					
LA Type	imperature life test	△L/L : Within ±10% Q:30min				
CAL45 Type	Δ.	△L/L : Within ±10% Q : 3011111				
LHL		Appearance : No abnormality				
FBA/FBR		Appearance . No abnormality inductance change . Within ±1070 Q change . Within ±5070 (Erich . thiny =2-2)				
FL05 Typ	20	Refer to individual specification				
FL06BT Typ		Appearance : No abnormality				
Test Methol LA, CA	od and Remarks] : Temperature : -25±2°C Duration : 1000 hrs Recovery : At least 1h : Temperature : -40±3°C Duration : 1000±24 h	of recovery under the standard removal from test chamber, followed by the measurement within 2hrs.				
FL	Recovery : 1 to 2hrs of recovery under the standard condition after the removal from the test chamber. FL : Temperature : -40±3°C Duration : 500 (+12, -0) hrs					
	Recovery : 1 to 2hrs of	recovery under the standard condition after the removal from the test chamber.				
28. High te	emperature life test					
LA Type	,					
CAL45 Type	e					
LHL	·					
FBA/FBR						
FL05 Typ	DB	Refer to individual specification				
FL06BT Typ		Appearance : No abnormality				
	od and Remarks	P. P. P. T.				
	: Temperature : 105±3°C Duration : 1000±24 h	rs recovery under the standard condition after the removal from the test chamber.				
	Duration : 500 (+12, - Recovery : 1 to 2hrs of	-0) hrs recovery under the standard condition after the removal from the test chamber.				

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

CAL Type, LH Type, FB Type, FL Type, LA Type

1. Circuit Design Operating environment 1. The products described in this specification are intended for use in general electronic equipment (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high Precautions reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance. 2. PCB Design Design 1. Please design insertion pitches as matching to that of leads of the component on PCBs. Precautions Technical Design consider-1. When Inductors are mounted onto a PC board, hole dimensions on the board should match the lead pitch of the component, if not, it will cause breakage of the terminals or cracking of terminal roots covered with resin as excess stress travels through the terminal legs 3. Considerations for automatic placement Adjustment of mounting machine Precautions 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. Technical ◆Adjustment of mounting machine consider-1. When installing products, care should be taken not to apply distortion stress as it may deform the products. ations 4. Soldering ◆Wave soldering 1. Please refer to the specifications in the catalog for a wave soldering. 2. Do not immerse the entire inductor in the flux during the soldering operation. Lead free soldering 1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently. Recommended conditions for using a soldering iron: Precautions · Put the soldering iron on the land-pattern · Soldering iron's temperature - Below 350°C • Duration - 3 seconds or less • The soldering iron should not directly touch the inductor. ◆Reflow soldering 1. As for reflow soldering, please contact our sales staff. Technical Lead free soldering consider-1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of ations the products. 5. Cleaning ◆Cleaning conditions Precautions 1. CAL type, LH type, LA Type Please do not do cleaning by a supersonic wave Technical Cleaning conditions 1. CAL type, LH type, LA Type If washing by supersonic waves, supersonic waves may deform products ations 6. Handling ◆Handling 1. Keep the inductors away from all magnets and magnetic objects. ◆Mechanical considerations 1. Please do not give the inductors any excessive mechanical shocks. Precautions 2. LH type If inductors are dropped onto the floor or a hard surface they should not be used. ◆Packing 1. Please do not give the inductors any excessive mechanical shocks. In loading, please pay attention to handling indication mentioned in a packing box (a loading direction / number of maximum loading / fragile item). ◆Handling There is a case that a characteristic varies with magnetic influence. Mechanical considerations Technical 1. There is a case to be damaged by a mechanical shock. consider-2. LH type ations There is a case to be broken by a fall. ◆Packing 1. There is a case that a lead wire could be deformed by a fall or an excessive shock 7. Storage conditions Storage 1.To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. Recommended conditions Precautions ·Ambient temperature 0~40°C ·Humidity Below 70% RH The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, inductors should be used within one year from the time of delivery In case of storage over 6 months, solderability shall be checked before actual usage Technical ◆Storage

consider-

ations

1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of

taping/packaging materials may take place

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

COMMON MODE CHOKE COIL (SMD) FOR HIGH-SPEED DIFFERENTIAL SIGNAL



REFLOW

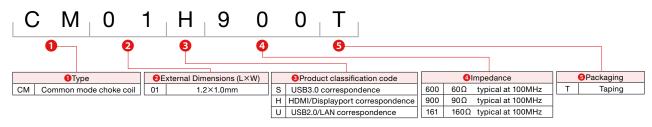
FEATURES

- CM01 Series is Wire-wound Structured Type Commom Mode Choke Coil which provides highly effective noise suppression characteristics without distorting the wave pattern of High-speed Differential Signal interface.
- Developed 1210 case-size by utilizing our wire-wound technologies.
 This small and wire-wound structured product has little transmission loss and keeps high common impedance up to GHz range.
- CM01S600: Suitable characteristics for super high speed differential signal such as USB3.0 and so on. Cutoff frequency is 10GHz.
- CM01H900: Suitable characteristics for high speed differential signal such as HDMI, DVI, Displayport and so on. Cut-off frequency is 8GHz.
- CM01U900: Suitable characteristics for differential signal such as USB2.0, LVDS, LAN and so on. Cut-off frequency is 3GHz. High rated current of this product makes it possible to replace 2012 size product for this product.
- CM01U161: Suitable characteristics for differential signal such as USB2.0, LVDS, LAN and so on. Cut-off frequency is 3GHz. High common impedance of this product works effectively on noise suppression.

APPLICATIONS

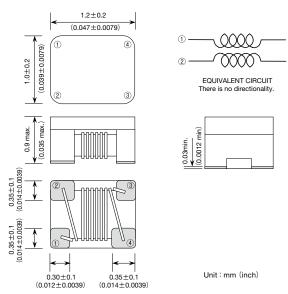
- Radiated noise suppression in the High-speed Diffrential Signal interfaces [HDMI, Serial-ATA, IEEE1394, LVDS, and USB2.0] of LCD-TV, Blu-ray players, and PCs.
- Countermeasure for degradation of receiver sensitivity caused by high frequency noise from high-speed differential signal of Cellular phones, Data Cards and Smartphones.
- Common mode noise suppression raised from the power line and audio signal in a small device.

ORDERING CODE



EXTERNAL DIMENSIONS/MINIMUM QUANTITY

CM01TYPE



Tuno	Minimum Quantity (pcs.)
Туре	Embossed tape
CM01[2 Lines] type	3000

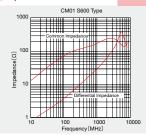
PART NUMBERS

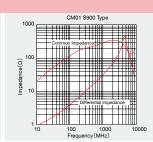
CM01 TYPE

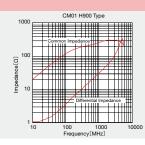
Ordering	EHS	No. of Lines		Impedance I00MHz)	DC resistance [Ω]	Rated current [mA]	Rated voltage [V] (D.C.)	Insulation resistance [MΩ]	Cut off frequency [GHz]	Characteristic impedance [Ω]
CM01S600T	RoHs	2	60typ.	43min.	0.4max.	300max.	20max.	100min.	10.0typ.	90typ.
CM01S900T	RoHS	2	90typ.	65min.	0.5max.	280max.	20max.	100min.	8.0typ.	90typ.
CM01H900T	RoHS	2	90typ.	65min.	0.5max.	280max.	20max.	100min.	8.0typ.	100typ.
CM01U900T	RoHs	2	90typ.	65min.	0.3max.	400max.	20max.	100min.	3.0typ.	_
CM01U161T	RoHs	2	160typ.	120min.	0.6max.	260max.	20max.	100min.	3.0typ.	_

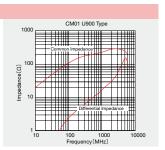
^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

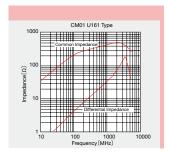
Impedance characteristics



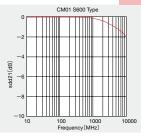


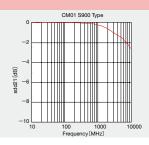


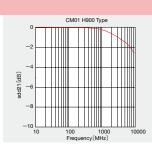


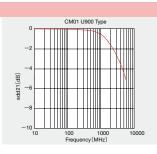


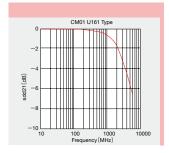
Transmission characteristic











^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

COMMON MODE CHOKE COILS (FOR DC AND SIGNAL LINES) SMD TYPE





REFLOW

FEATURES

- Available in embossed tape and reel.
- Highly coupled coil construction ideal for common mode noise attenuation.

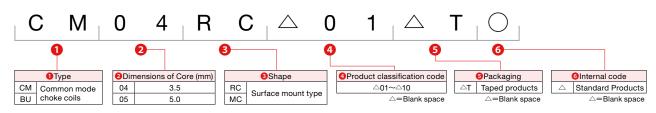
OPERATING TEMP.

−25°C~105°C (Including self-generated heat)

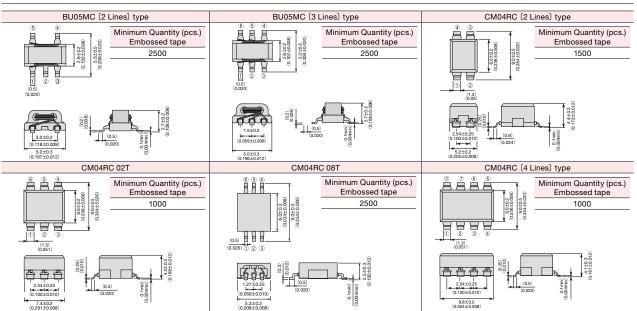
APPLICATIONS

- Immunity against undesirable external line radiation fields and broadcast waves generated by multifunction telephone sets, PBXs, and facsimile machines.
- Preventive measure against DC line noise in electronic equipment.
- Suppresses radiated emissions from secondary power supplies and signal lines on AC adapters, battery chargers, and digital equipment.
- Excellent for reducing radiated noise in DVC (digital video cameras) and DSC (digital still cameras)
- Offers high speed differential mode noise attenuation in USB and IEEE1394 connectors in personal computers, printers, scanners and other computer peripherals.

ORDERING CODE



EXTERNAL DIMENSIONS/MINIMUM QUANTITY



The values without tolerance are for reference only.

Unit:mm (inch)

PART NUMBERS

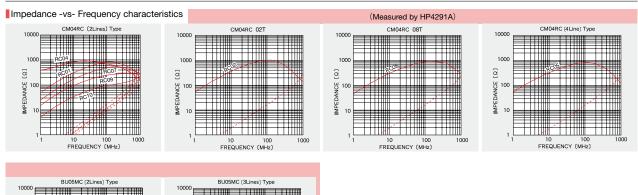
●CM04RC Type

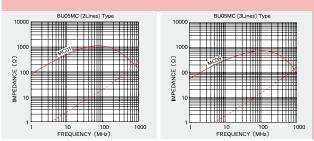
Ordering code	EHS (Environmental Hazardous Substances)	No. of Lines	Impedance [Ω] (typical)	DC resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] (D.C.)	Insulation resistance [MΩ] (min.)
CM04RC01T	RoHS	2	800 (at 100MHz)	0.06	1.5		
CM04RC04T	RoHS		900 (at 20MHz)	0.1	1.3		
CM04RC07T	RoHS		500 (at 160MHz)	0.06	2.5		
CM04RC09T	RoHS		270 (at 200MHz)	0.03	3.0	F0	100
CM04RC10T	RoHS		100 (at 200MHz)	0.02	4.0	50	100
CM04RC02T	RoHS	3	1000 (at 100MHz)	0.18	0.5		
CM04RC08T	RoHS	3	1000 (at 200MHz)	0.2	0.5		
CM04RC05T	RoHS	4	800 (at 100MHz)	0.2	0.5		

BU05MC Type

Ordering code	EHS (Environmental Hazardous Substances)	No. of Lines	Impedance [Ω] (typical)	DC resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] (D.C.)	Insulation resistance [MΩ] (min.)
BU05MC01T	RoHS	2	1000 (at 60MHz)	0.12	1	50	100
BU05MC08T	RoHS	3	700 (at 60MHz)	0.11	0.5	50	100

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.





Common mode

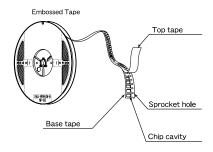
Normal mode

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

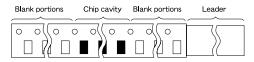
1 Minimum Quantity

Туре	Minimum Quantity (pcs.) Embossed tape
CM01 [2 Lines] type	3000
CM04RC [2 Lines] type	1500
CM04RC 02T	1000
CM04RC 08T	2500
CM04RC [4 Lines] type	1000
BU05MC [2 Lines] type	2500
BU05MC [3 Lines] type	2500

2Tape Material



3 Leader and Blank Portion

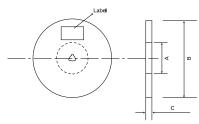


Direction of tape feed

Туре	Leader	Blank portions (Leader side)	Blank portions (Chip cavity side)
CM01	200~400 (7.87~15.75)	160~200 (6.30~7.87)	160 (6.30) or more
CM04RC	150 (5.89)	80 (3.14)	80 (3.14)
BU05MC	150 (5.89)	80 (3.14)	80 (3.14)

Unit:mm (inch)

4 Reel size

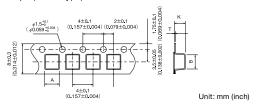


Type	A	В	С
CM01	φ60+1/-0	φ180+0/-3	10.0±1.5
	(φ2.36+0.039/-0)	(φ7.09+0/-0.118)	(0.394±0.059)
CM04RC	φ100±1	φ330±2	18±1.5
	(φ3.94±0.039)	(φ12.99±0.079)	(0.709±0.059)
BU05MC	φ80±1	φ330±2	13.5±1
	(φ3.15±0.039)	(φ12.99±0.079)	(0.53±0.039)

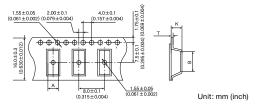
Unit:mm (inch)

⑤Taping dimensions

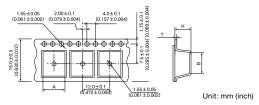
Embossed tape (CM01 type)



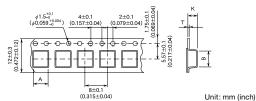
Embossed tape (CM04RC type) 8mm pitch (0.31 inches pitch)



Embossed tape (CM04RC type) 12mm pitch (0.472 inches pitch)



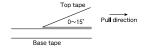
Embossed tape (BU05MC type)



Туре	Lines	Insertion	Chip	cavity	tape thickness		
	Lilles	pitch	Α	В	K	T	
CM01	2	4.0±0.1	1.16±0.1	1.41±0.1	0.98±0.1	0.3max.	
	2	8.0±0.1	5.7±0.1	9.65±0.1	5.2max	0.4±0.05	
CM04RC	3(02T)	12.0±0.1	9.8±0.1	7.7±0.1	5.0max	0.38±0.05	
CM04RC	3(08T)	8.0±0.1	5.7±0.1	9.8±0.1	3.1max	0.4±0.05	
	4	12.0±0.1	10.3±0.1	10.3±0.1	5.0max	0.3±0.05	
BU05MC	2	8.0+0.1	5.35±1.5	5.7±0.2	3.2±0.1	0.4±0.05	
	3	0.U±U.1	3.33±1.3	3.7 ± 0.2	3.2±0.1		

Unit:mm (inch)

6Top Tape Strength



 CM01
 The top tape requires a peel-off force of 0.1 to 1.0N in the direction of the arrow as illutrated above.

CM04RC, BU05MC

The top tape requires a peel-off force of 0.1 to 0.7N in the direction of the arrow as illutrated above.

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

COMMON MODE CHOKE COILS (FOR DC AND SIGNAL LINES) LEADED TYPE







WAVE

FEATURES

- Highly reliable, compact and lightweight
- Easily inserted into the PCB

APPLICATIONS

TLF Type :

Countermeasure for noise in the low-frequency (AM) broad-casting band. Shields against radiated emissions in the broadcasting frequency for multi-functional telephone sets. PBXs, faxes, etc.

CM/BU Type :

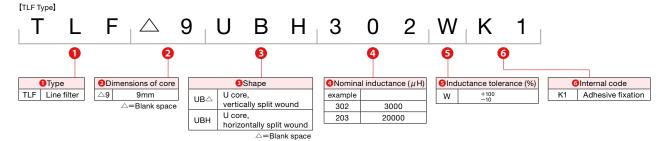
Countermeasure for noise in the high-frequency (MHz) band

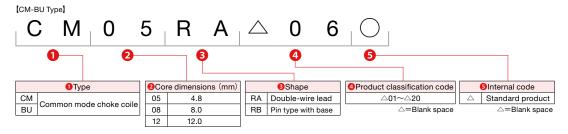
OPERATING TEMP.

TLF Type	-25°C~+105°C
CM Type	-25°C~+105°C

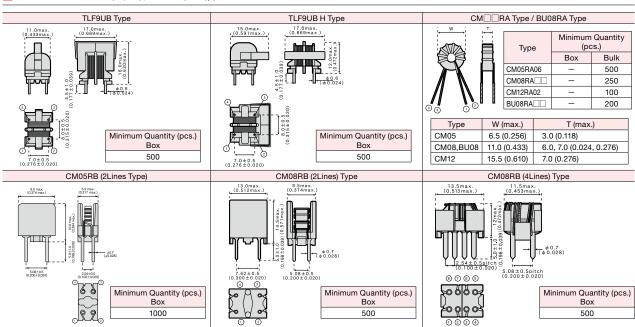
(Including self-generated heat)

ORDERING CODE





EXTERNAL DIMENSIONS/MINIMUM QUANTITY



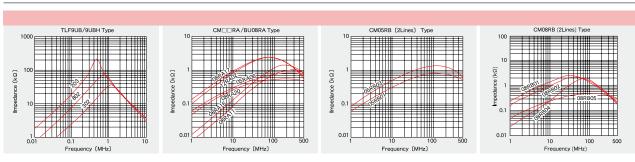
Unit : mm (inch)

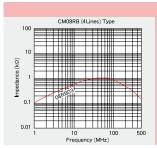
^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

Ordering code	EHS (Environmental Hazardous Substances)	No. of lines	Inductance [µH] [⁺¹⁰⁰ / ₋₁₀ %]	DC resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] D.C.	Insulation resistance [MΩ] (min.)	Impedance [KΩ] (Reference values)
TLF9UBH 302WK1	RoHS		3000	1.5	0.4			≥20 (at 1MHz)
TLF9UB 302WK1	RoHS		3000	1.5	0.4	50	100	≦20 (at 11VII 12)
TLF9UBH 802WK1	RoHS	,	8000	3.0	0.3			≧40 (at 700kHz)
TLF9UB 802WK1	RoHS]	8000	3.0	0.3	30		≥40 (at 700kHz)
TLF9UBH 203WK1	RoHS		20000	6.5	0.18			≧150 (at 500kHz)
TLF9UB 203WK1	RoHS		20000	0.5	0.18			≤ 100 (at 500KHZ)

Ordering of	rdering code		EHS (Environmental Hazardous Substances)	No.of lines	Inductance [µH] [at 1kHz]	Impedance [Ω] (typical)	DC resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] D.C.	Insulation resistance [MΩ] (min.)
CM05RA	06		RoHS		0.7 min.	700 (at 200MHz)	0.050	1.5		
BU08RA	11		RoHS		0.7~1.3	1000 (at 250MHz)	0.013	4.0		
DUUONA	16		RoHS] [1.19~2.21	1200 (at 200MHz)	0.011	3.0		
CM08RA	17		RoHS] [15.0 min.	2000 (at 80MHz)	0.040	2.4]	
20 Z		RoHS		6.0 min.	500 (at 200MHz)	0.020	5.5		l	
CM12RA	02		RoHS	2	10.0 min.	2000 (at 80MHz)	0.040	3.0		
CM05RB	01		RoHS] ~ [7.0 min.	700 (at 70MHz)	0.050	2.0	50	100
CIVIUSAB	03		RoHS] [15.0 min.	1400 (at 100MHz)	0.060	1.5		
	01		RoHS] [40.0 min.	2500 (at 30MHz)	0.040	2.0		
	02		RoHS] [15.0 min.	2000 (at 50MHz)	0.040	2.4]	
CM08RB	04		RoHS] [110.0 min.	2000 (at 70MHz)	0.040	3.0]	
	05		RoHS		6.0 min.	450 (at 100MHz)	0.020	4.0	1	
	03		RoHS	4	15.0 min.	1000 (at 50MHz)	0.050	2.0		

■ ELECTRICAL CHARACTERISTICS





Measuring conditions

Equipment

: HP4291A, HP4294A Vosc : 0.5V (CM/BU type)(TLF type)

Measuring circuit:

To impedance analyzer

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

COMMON MODE CHOKE COILS (FOR AC LINES) LEADED TYPE



WAVE

FEATURES

- TLH10UAH TYPE : Thin configuration (Hybrid choke、Height 10mmMAX)
- TLH10UA(B) TYPE: Ordinary configuration (Hybrid choke)
- TLF10UAH TYPE: Thin configuration (Height 10mmMAX)
- TLF9UA(H) K1 TYPE: Small-sized configurationTLF14CB(H) K1 TYPE: Ordinary configuration
- TLF24HB(H) K1TYPE: Large current capacity for power supply line use

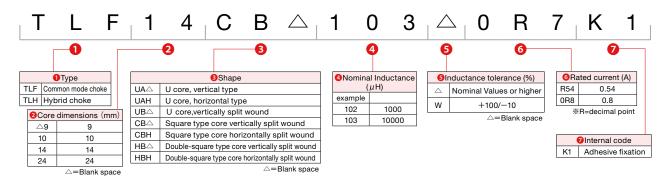
APPLICATIONS

 As a preventive measure against noise terminal voltage or power supply noise in TV's SW power supplies, NC machines, computer systems, peripheral units, measuring instruments, and controllers.

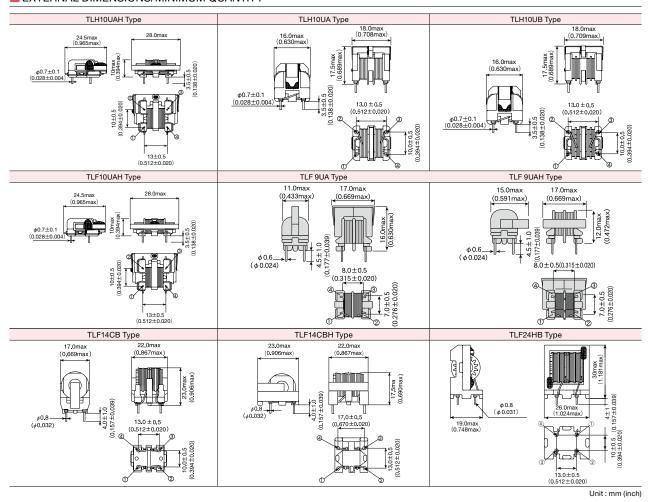
OPERATING TEMP.

-25°C~+105°C (Including self-generated heat)

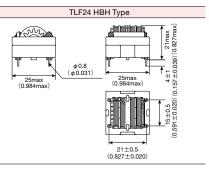
ORDERING CODE



EXTERNAL DIMENSIONS/MINIMUM QUANTITY



^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.



Туре	Minimum Quantity (pcs.) Box
TLH Type	500
TLF Type	500

Unit: mm (inch)

PART NUMBERS

TLH10UAH Type (Hybrid choke)

Ordering code	EHS	Common Mode Inductance [mH]	Inductance Tolerance	Normal Mode Inductance [mH](Typ.)	DC Resistance [Ω] (max.) Rated current [A] (max.)		Rated voltage [V] (max.)	Applicable frequency [MHz] Reference
TLH10UAH872 0R7	RoHS	8.7		0.70	1.00	0.7		
TLH10UAH992 0R6	RoHS	9.9	min.	0.85	1.35	0.6	AC250	0.1~10
TLH10UAH123 0R5	RoHS	12.0		1.06	1.60	0.5		

TLH10UA Type(Hybrid choke)

Ordering code	EHS	Common Mode Inductance [mH]	Inductance Tolerance	Normal Mode Inductance [mH](Typ.)	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] (max.)	Applicable frequency [MHz] Reference
TLH10UA 901 2R0	RoHS	0.9		0.067	0.089	2.0		
TLH10UA 112 1R8	RoHS	1.1		0.087	0.126	1.8		
TLH10UA 152 1R6	RoHS	1.5		0.126	0.171	1.6	AC250	0.1~10
TLH10UA 212 1R4	RoHS	2.1		0.175	0.222	1.4		
TLH10UA 282 1R2	RoHS	2.8	min.	0.215	0.272	1.2		
TLH10UA 432 1R0	RoHS	4.3	111111.	0.330	0.398	1.0		0.1.010
TLH10UA 622 0R8	RoHS	6.2		0.430	0.578	0.8		
TLH10UA 872 0R7	RoHS	8.7		0.644	0.878	0.7		
TLH10UA 992 0R6	RoHS	9.9		0.836	1.138	0.6		
TLH10UA 143 0R5	RoHS	14.0		1.256	1.567	0.5		

TLH10UB Type(Hybrid choke)

*, *								
Ordering code	EHS	Common Mode Inductance [mH]	Inductance Tolerance	Normal Mode Inductance [mH](Typ.)	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] (max.)	Applicable frequency [MHz] Reference
TLH10UB 701 2R0	RoHS	0.7		0.056	0.097	2.0		
TLH10UB 112 1R7	RoHS	1.1		0.068	0.133	1.7		
TLH10UB 142 1R4	RoHS	1.4		0.113	0.214	1.4		
TLH10UB 232 1R2	RoHS	2.3		0.160	0.274	1.2		
TLH10UB 352 1R0	RoHS	3.5	min.	0.232	0.422	1.0	AC250	0.1~10
TLH10UB 442 0R8	RoHS	4.4		0.328	0.576	0.8		
TLH10UB 872 0R7	RoHS	8.7		0.580	0.982	0.7		
TLH10UB 972 0R6	RoHS	9.7		0.735	1.314	0.6		
TLH10UB 113 0R5	RoHS	11.0		0.877	1.577	0.5		

TLF10UAH Type

Ordering code	EHS	Common Mode Inductance [mH]	Inductance Tolerance	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] (max.)	Applicable frequency [MHz] Reference
TLF10UAH872 0R7	RoHS	8.7		1.00	0.7		
TLF10UAH992 0R6	RoHS	9.9	min.	1.35	0.6	AC250	0.1~10
TLF10UAH123 0R5	RoHS	12.0		1.60	0.5		

●TLF 9UA Type

•							
Ordering code	EHS	Common Mode Inductance [mH]	Inductance Tolerance	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] (max.)	Applicable frequency [MHz] Reference
TLF 9UA 102W0R8K1	RoHS	1.0		0.5	0.80		
TLF 9UA 202WR54K1	RoHS	2.0		1.0	0.54	AC250	0.1~10
TLF 9UA 302WR42K1	RoHS	3.0	+100%/10%	1.5	0.42		
TLF 9UA 502WR32K1	RoHS	5.0	T10076/-1076	2.5	0.32		
TLF 9UA 802WR25K1	RoHS	8.0		4.0	0.25		
TLF 9UA 103WR23K1	RoHS	10.0		4.5	0.23		

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

PART NUMBERS

TLF 9UAH Type

Ordering code	EHS	Common Mode Inductance [mH]	Inductance Tolerance	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] (max.)	Applicable frequency [MHz] Reference
TLF 9UAH102W0R8K1	RoHS	1.0		0.5	0.80		
TLF 9UAH202WR54K1	RoHS	2.0	14000/ / 400/	1.0	0.54	AC250	0.1~10
TLF 9UAH302WR42K1	RoHS	3.0		1.5	0.42		
TLF 9UAH502WR32K1	RoHS	5.0	+100%/-10%	2.5	0.32	AC250	0.1~10
TLF 9UAH802WR25K1	RoHS	8.0		4.0	0.25		
TLF 9UAH103WR23K1	RoHS	10.0		4.5	0.23		

TLF14CB Type

Ordering code	EHS	Common Mode Inductance [mH]	Inductance Tolerance	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] (max.)	Applicable frequency [MHz] Reference
TLF14CB 102 1R5K1	RoHS	1.0		0.10	1.5		
TLF14CB 222 1R2K1	RoHS	2.2		0.18	1.2		
TLF14CB 332 1R0K1	RoHS	3.3		0.32	1.0		
TLF14CB 472 1R0K1	RoHS	4.7		0.38	1.0		
TLF14CB 562 0R8K1	RoHS	5.6		0.42	0.8		
TLF14CB 682 0R8K1	RoHS	6.8	min.	0.60	0.8	AC250	0.1~10
TLF14CB 103 0R7K1	RoHS	10.0	min.	0.85	0.7	AC250	0.1~10
TLF14CB 223 0R4K1	RoHS	22.0		1.7	0.4		
TLF14CB 333 0R3K1	RoHS	33.0		2.7	0.3		
TLF14CB 473 0R2K1	RoHS	47.0		3.6	0.2		
TLF14CB 563 0R2K1	RoHS	56.0		5.0	0.2		
TLF14CB 683 0R2K1	RoHS	68.0		6.5	0.2		

TLF14CBH Type

Ordering code	EHS	Common Mode Inductance [mH]	Inductance Tolerance	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] (max.)	Applicable frequency [MHz] Reference
TLF14CBH102 1R5K1	RoHS	1.0		0.10	1.5		
TLF14CBH222 1R2K1	RoHS	2.2		0.18	1.2		
TLF14CBH332 1R0K1	RoHS	3.3		0.32	1.0		
TLF14CBH472 1R0K1	RoHS	4.7		0.38	1.0		
TLF14CBH562 0R8K1	RoHS	5.6		0.42	0.8		
TLF14CBH682 0R8K1	RoHS	6.8	min.	0.60	0.8	AC250	0.1~10
TLF14CBH103 0R7K1	RoHS	10.0	111111.	0.85	0.7	AC250	0.11-010
TLF14CBH223 0R4K1	RoHS	22.0		1.7	0.4		
TLF14CBH333 0R3K1	RoHS	33.0		2.7	0.3		
TLF14CBH473 0R2K1	RoHS	47.0		3.6	0.2		
TLF14CBH563 0R2K1	RoHS	56.0		5.0	0.2		
TLF14CBH683 0R2K1	RoHS	68.0		6.5	0.2		

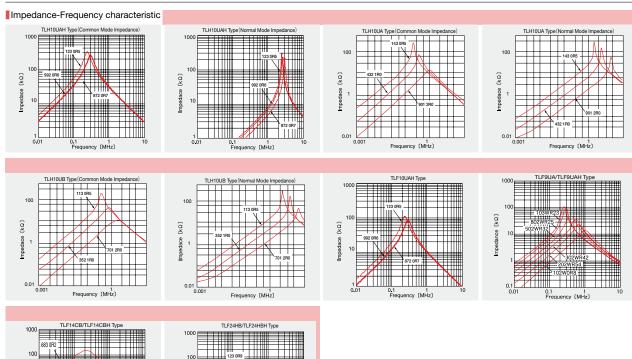
●TLF24HB Type

- · - · - · · · · · · · · · · · · · · ·							
Ordering code	EHS	Common Mode Inductance [mH]	Inductance Tolerance	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] (max.)	Applicable frequency [MHz] Reference
TLF24HB 122 3R0K1	RoHS	1.2		0.045	3.0		
TLF24HB 222 2R2K1	RoHS	2.2		0.080	2.2		
TLF24HB 272 2R0K1	RoHS	2.7		0.090	2.0		
TLF24HB 332 1R8K1	RoHS	3.3		0.120	1.8		
TLF24HB 392 1R5K1	RoHS	3.9		0.130	1.5		
TLF24HB 562 1R4K1	RoHS	5.6		0.187	1.4		
TLF24HB 682 1R2K1	RoHS	6.8	min.	0.254	1.2	AC250	0.1~10
TLF24HB 822 1R0K1	RoHS	8.2		0.275	1.0		
TLF24HB 103 1R0K1	RoHS	10.0		0.345	1.0		
TLF24HB 123 0R9K1	RoHS	12.0		0.350	0.9		
TLF24HB 183 0R8K1	RoHS	18.0		0.550	0.8		
TLF24HB 273 0R6K1	RoHS	27.0		0.880	0.6		
TLF24HB 333 0R5K1	RoHS	33.0		1.150	0.5		

●TLF24HBH Type

Ordering code	EHS	Common Mode Inductance [mH]	Inductance Tolerance	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] (max.)	Applicable frequency [MHz] Reference
TLF24HBH122 3R0K1	RoHS	1.2		0.045	3.0		
TLF24HBH222 2R2K1	RoHS	2.2		0.080	2.2		
TLF24HBH272 2R0K1	RoHS	2.7		0.090	2.0		
TLF24HBH332 1R8K1	RoHS	3.3		0.120	1.8		
TLF24HBH392 1R5K1	RoHS	3.9		0.130	1.5		
TLF24HBH562 1R4K1	RoHS	5.6		0.187	1.4		
TLF24HBH682 1R2K1	RoHS	6.8	min.	0.254	1.2	AC250	0.1~10
TLF24HBH822 1R0K1	RoHS	8.2		0.275	1.0		
TLF24HBH103 1R0K1	RoHS	10.0		0.345	1.0		
TLF24HBH123 0R9K1	RoHS	12.0		0.350	0.9		
TLF24HBH183 0R8K1	RoHS	18.0		0.550	0.8		
TLF24HBH273 0R6K1	RoHS	27.0		0.880	0.6		
TLF24HBH333 0R5K1	RoHS	33.0		1.150	0.5		

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.



Frequency (MHz)

Test conditions Equipment : HP-4294A

Test circuit: W 孤

To impedance analyzer

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

PACKAGING

Minimum Quantity

CM/BU Type

Tuno	Minimum Quantity (pcs.)				
Туре	Box	Bulk			
CM05RA06	_	500			
CM05RB□□	1000	_			
CM08RA□□	_	250			
CM08RB□□	500	_			
CM12RA02	_	100			
BU08RA□□	_	200			

TL Type

Туре	Minimum Quantity (pcs.) Box
TLH10UAH	
TLH10UA	
TLH10UB	
TLF10UAH	500
TLF9UA□	300
TLF9UB□	
TLF14CB□	
TLF24HB	

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

BALUN TRANSFORMERS



MB: WAVE MC: REFLOW

FEATURES

- High stability due to pair wire windings
- MC type: pins are molded into the base to create a singular structure
- This item can be custom designed to meet customer requirements

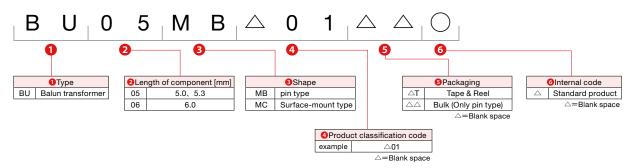
APPLICATIONS

- Impedance transformers
- Distribution transformers

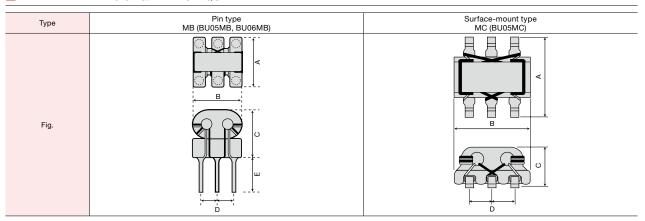
OPERATING TEMP.

■ -25°C ~ 105 °C (Including self-generated heat)

ORDERING CODE



EXTERNAL DIMENSIONS/MINIMUM QUANTITY

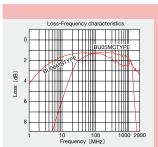


Tuno	^	В	С	D	Е	Minimum Quantity (pcs.)	
Type	A	В		"	_	Box	Taping
BU05MB	5.5 max. (0.217 max.)	5.5 max. (0.217 max.)	6.0 max. (0.236 max.)	1.75±0.2 (0.069±0.008)	3.5 (0.138)	200	_
BU06MB	8 max. (0.315 max.)	8 max. (0.315 max.)	8 max. (0.315 max.)	2.25±0.2 pitch (0.089±0.008)	3.5~5.0 (0.138±0.197)	150	_
BU05MC	5.3±0.5 (0.209±0.020)	5.0±0.3 (0.197±0.012)	2.7±0.2 (0.106±0.008)	1.5±0.2 pitch (0.059±0.008)	-	_	2500
							Jnit : mm (inch)

Recommended Land Patterns
[BU05MC]

0.5
0.5
0.5
0.5
1.4
3.2
1.4
| \(\rightarrow \) | \(\rightarrow \) | \(\rightarrow \) | 1.4

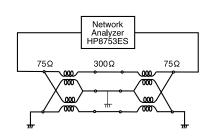
ELECTRICAL CHARACTERISTICS



The following chart shows typical ranges for operating characteristics.

- Please specify the following when ordering.

 1 loss
- 2 standing wave ratio (VSWR)3 operating frequency
- specified test circuit

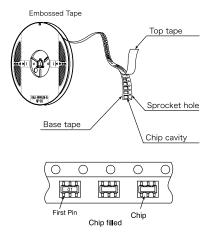


^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

1 Minimum Quantity

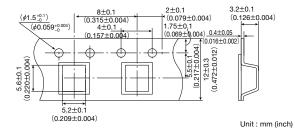
T	Minimum Quantity (pcs.)				
	Туре	Box	Taping		
	BU05MC	_	2500		
	BU05MB	200	_		
	BU06MB	150	_		

②Tape material

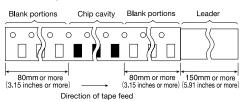


3 Taping dimensions

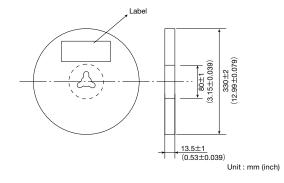
Embossed tape 12mm wide (0.472 inches wide)



4 Leader and Blank portion

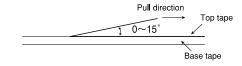


⑤Reel size



6Top Tape Strength

The top tape requires a peel-off force of 0.1 to 0.7N in the direction of the arrow as illustrated below.



^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

neliabili i Daia					
Operating Temperature Range					
CM01	-40°C∼+105°C				
CM04RC					
BU05MC	¹ −25℃~+105℃				
Test Method and Remarks					
Including self-generated heat					
2. Storage Temperature Range					
CM01	T				
CM04RC					
BU05MC					
[Test Method and Remarks]					
−5 to +40°C in taped packaging					
3. Rated current					
CM01					
CM04RC	Within the specified tolerance.				
BU05MC					
Test Method and Remarks					
The maximum value of DC current with	nin a specified rise of temperature individually.				
4. Impedance					
CM01					
CM04RC	Within the specified tolerance.				
BU05MC					
[Test Method and Remarks] Measuring equipment: HP 4291A or it	to optivalent				
Measuring frequency: Specified freq					
5. DC Resisitance CM01					
CM04RC	Within the specified tolerance.				
BU05MC	The specified to state of				
Test Method and Remarks					
SMD transformer · Commom mode ch					
Measuring equipment : DC ohm met	er				
6. Resistance to flexure of substrate					
CM01	Within the specified tolerance.				
CM04RC	Refer to the individual specification.				
BU05MC	Total of the manned specimens.				
Test Method and Remarks According to JIS C 0051	Pressig jig				
According to the o too.	10/ ²⁰ 				
CM01	CM04PC-PH05MC				
Warp 2mm	3mm				
Pressing speed 0	.5mm/sec.				
Duration	5±1sec. 45±2mm 45±2mm				
-					
7. Dielectric resistance : between wire	- S				
CM01					
CM04RC	_100MΩ min.				
BU05MC					
[Test Method and Remarks] Applied voltage: Rated voltage					
Applied voltage - natiet voltage Duration : 60 sec.					
9. Dated voltage					
8. Rated voltage CM01	T				
CM04RC	Within the specification.				
BU05MC	1				
Withstanding voltage: between wir CM01	es T				
CM04RC	No abnormality.				
BU05MC	NO abitomany.				
Test Method and Remarks					
Applied voltage: Regulation voltage, [DC250V(CM04RC), DC125V(BU05MC)				
Duration : 60 sec.					
10. Resistance to vibration					
CM01	No abnormality observed in appearance				
CM04RC	Refer to the individual specification.				
BU05MC					
[Test Method and Remarks] According to JIS C 0040					
Directions : 2 hrs each in X, Y	r/, and Z directions. Total: 6 hrs				
Frequency range: 10 to 55 to 10 Hz Amplitude: 1.5mm (Shall not	: (1 min.) : exceed acceleration 196m/s²)				
,	· · · · · ·				

Mounting method: soldering onto printed board

Recovery: At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

11. Solderability				
CM01	At least 90% of terminal electrode is covered by new solder.			
CM04RC	At least 75% of tarminal alastrada in aguarad bu pay caldar			
BU05MC	At least 75% of terminal electrode is covered by new solder.			

[Test Method and Remarks]

	CM01	CM04RC+BU05MC
Solder temperature	245±5℃	235±5℃
Duration	3±1sec.	2±0.5sec.
Immersion depth	_	Up to 0.5mm from terminal root

12. Resistance to solder Heat		
CM01 Within the specified tolerance.		
CM04RC	Defends the individual and ifficial	
BU05MC	Refer to the individual specification.	

[Test Method and Remarks]

	CM01	CM04RC · BU05MC	
Reflow soldering	Preheating : 150 to 180°C 1 to 2min Peak : $255\pm5^\circ$ C 5sec. $230\pm5^\circ$ C 30~40sec. Number of reflow : Within 2 times	Preheating: 100 to 150°C 1 to 2min Peak: 230 to 240°C within 5sec. More than 200°C within 40sec. Number of reflow: Within 2 times	
Manual soldering	-	Solder temperature: 350±5°C Duration: 3±1sec. Recovery: 1 to 2hrs of recovery under the standard condition after the test.	

13. Thermal shock	
CM01	Within the specified tolerance.
CM04RC	B. C. L. H. C. E. M. L. L. C. C.
BLI05MC	Refer to the individual specifica

[Test Method and Remarks] Accoding to JIS C 0025 Conditions of 1 cycle

Cton	Temperature (°C)		Time (min)	
Step	CM01	CM04RC+BU05MC	CM01	CM04RC·BU05MC
1	-40±3℃	-25±3℃	30:	±3
2	Room Temp.	Room Temp.	3	3
3	85±2℃	85±3℃	30:	±3
4	Room Temp.	Room Temp.	3	3

14. Loading under damp heat		
CM01	Within the specified tolerance.	
CM04RC		
BU05MC	Refer to the individual specification.	

[Test Method and Remarks]

	CM01	CM04RC+BU05MC
Temperature	60±2℃ 40±3℃	
Humidity	90~95%RH	
Applied current	Rated current	
Duration	1000±24hrs	

Recovery: Recovery under the standard condition after removal from test chamber. CM01: Should be measured within 2 to 48hours. CM04RC+BU05MC: Leave within 1 to 2 hours.

15. High temperature life test		
CM01 -		
CM04RC	Defends the individual analification	
BU05MC	Refer to the individual specification.	

[Test Method and Remarks]

	CM04RC · BU05MC
Temperature	85±3℃
Duration	1000±24hrs

Recovery: Recovery under the standard condition after removal from test chamber.

CM01 : Should be measured within 2 to 48hours. CM04RC • BU05MC : Leave within 1 to 2 hours.

CM01	Within the specified tolerance.	
CM04RC	Refer to the individual specification.	
BU05MC		

(Test Method and Remarks)

	CM01 CM04RC · BU05MC	
Temperature	-40±2℃	-40±3℃
Applied current	1000±24hrs	

Recovery : Recovery under the standard condition after removal from test chamber. CM01 : Should be measured within 2 to 48hours.

CM04RC · BU05MC : Leave within 1 to 2 hours.

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

17. Loading at high temperature life test		
CM01	Within the specified tolerance.	
CM04RC		
BU05MC	7-	

[Test Method and Remarks]

	CM01
Temperature	105±2℃
Applied current	Rated current
Duration	1000±24hrs

Recovery: Recovery under the standard condition after removal from test chamber.

CM01: Should be measured within 2 to 48hours.

CM04RC • BU05MC: Leave within 1 to 2 hours.

Note on standard condition :

"standard condition" referred to herein is defined as follows: 5 to 35°C of temperature, 45 to 85% relative humidity and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:
In order to provide correlation data, the test shall be conducted under condition of 20±2°C of temperature, 45 to 85% relative humidity and 86 to 106kPa of air pressure.
Unless otherwise specified, all the tests are conducted under the "standard condition."

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

CM04RC, BU05MC, CM01

1. Circuit Design Operating environment 1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high Precautions reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance. 2. PCB Design ◆Land pattern design Precautions 1. Please contact any of our offices for a land pattern, and refer to a recommended land pattern of specifications Land pattern design Surface Mounting Mounting and soldering conditions should be checked beforehand. Applicable soldering process to these products is reflow soldering only. Recommended Land Patterns [CM04RC] [BU05MC] [CM01] (2 Lines) (3 Lines) (4 Lines) 1.6 \$0.45 Technical 1.6 1.6 considerations 0.65 1.55 6.7 6.7 67 3.2 \$0.45 $|\longleftrightarrow|\longleftrightarrow|\longleftrightarrow|$ 0.4 0.3 0.4 1.6 1.6 |←→| 1.1 $\langle \rightarrow | \leftrightarrow | \leftrightarrow \rangle$ |< >|< >|< >|< >|< >| 1.8 0.74 1.8 0.74 1.8 0.74 1.8 1.8 0.74 1.8 1.8 0.74 1.8 0.74 1.8 Unit: mm 3. Considerations for automatic placement ◆Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards Precautions 2. Mounting and soldering conditions should be checked beforehand Technical consider-1. When installing products, care should be taken not to apply distortion stress as it may deform the products ations 4. Soldering 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. 2. This product can be used reflow soldering only 3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering. Lead free soldering 1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently. Recommended conditions for using a soldering iron Precautions [CM04RC, BU05MC] · Put the soldering iron on the land-pattern Soldering iron's temperature - Below 350°C · Duration - 3 seconds or less The soldering iron should not directly touch the inductor. · Please do not conduct an adjustment with a soldering iron because the wire would be broken due to its thinness Technical consider 1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products. ations 5. Cleaning ◆Cleaning conditions Precautions 1. Please contact any of our offices for a cleaning. 6. Handling ◆Handling 1. Keep the product away from all magnets and magnetic objects ◆Breakaway PC boards (splitting along perforations) 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations Precautions 1. Please do not give the product any excessive mechanical shocks 2. Please do not add any shock and power to a product in transportation. ◆Pick-up pressure 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push onto an exposed part of ferrite cores. ◆Packing 1. Please avoid accumulation of a packing box as much as possible ♦Handling 1. There is a case that a characteristic varies with magnetic influence. ◆Breakaway PC boards (splitting along perforations) 1. The position of the product on PCBs shall be carefully considereed to minimize the stress caused from splitting of the PCBs. Technical Mechanical considerations 1. There is a case to be damaged by a mechanical shock. ations 2. There is a case to be broken by the handling in transportation. ◆Pick-up pressure 1. An excessive shock or stress may cause a damage to the product or a detrioration of a characteristic. Packing 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products 7. Storage conditions Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. Recommended conditions Precautions Ambient temperature : 0~40°C, Humidity : Below 70% RH The ambient temperature must be kept below 30°C. Even under ideal storage conditions, the solderability of electrodes may decrease gradually. For this reason, the products should be used within one year from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage.

Technical

consider-

♦Storage

Downloaded from **Elcodis.com** electronic components distributor

oftaping/packaging materials may take place.

1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

RELIABILITY DATA									
Operating Temperature Range									
CM-RA/BU-RA Type									
CM-RB Type	_25~+105°C	−25~+105°C							
TLH, TLF Type									
	[Test method and remarks] Including temperature rise due to self-generated heat.								
moraumy temperature need due to	gonerated nea								
2. Storage temperature range									
CM-RA/BU-RA Type CM-RB Type		40 1050							
TLH, TLF Type		−40~+85°C							
3. Rated current									
CM-RA/BU-RA Type CM-RB Type	Within the sne	Within the specified range							
TLH, TLF Type	vvidilii die spe	Tanama are specializa range							
[Test method and remarks] CM:The maximum value of DC cu TLH10U, TLF10UAH: The maximu TLF9UA, 14CB: The maximum val TLF9UB: The maximum value of I	m value of AC curre lue of AC current wi	ent within the tempera thin the temperature	ature r rise of	rise of 60℃					
4. Inductance									
CM-RA/BU-RA Type									
CM-RB Type	Within the spe	Within the specified tolerance							
TLH, TLF Type									
[Test method and remarks] CM:									
CM: Measuring equipment : 4263A (HP) or its equivalent Measuring frequency : 1kHz									
TLF9U:									
Measuring equipment: Impeda Measuring frequency: 1kHz Measuring voltage: 0.35Vos	•	32A) or its equivalent							
TLH, TLF (except TLF9U): Measuring equipment: LCR me Measuring frequency: 1kHz Measuring voltage: 1.0V	eter 4284A or its equ	uivalent							
5. DC resistance									
CM-RA/BU-RA Type CM-RB Type	Within the sne	Within the specified tolerance							
TLH, TLF Type	- Vitaliii tile opt	Joined tolerande							
[Test method and remarks] CM, TLH, TLF : Measuring equipment : DC ohmmeter									
6. Terminal strength tensile force									
CM-RA/BU-RA Type									
CM-RB Type	No abnormali	No abnormality							
TLH, TLF Type									
[Test method and remarks] CM: Fix the component in the dire	ection to draw termi	nal and gradually apr	olv ter	nsile force as detailed in indiviual s	pecifications.				
·			,						
TLF9U : Apply the stated tensile for		irection to draw termir	nal.	TLH, TLF (except TLF9U): Apply th			ion to draw terminal		
Nominal wire diameter tensile \$\phi\$d [mm]	force [N]	duration [s]		Nominal wire diameter tensile ϕ d [mm]	force [N]	duration [s]			
φ0.6	5	30±5		φ0.8	10	30±5			
							•		
7. Insulation resistance between w	vires								
CM-RA/BU-RA Type									
CM-RB Type	100MΩ min.	100M Ω min.							
TLH, TLF Type									
Test method and remarks CM, TLH, TLF: Applied voltage: Rated voltage (CM-RA/BU-RA, CM-RB) : 500VDC (TLH, TLF (except TLF9UB)) : 250VDC (TLF9UB)									
Duration	: 60sec.								
8. Insulation resistance between w	rire and core								
CM-RA/BU-RA Type									
CM-RB Type									
TLH, TLF Type	100MΩ min.								
Test method and remarks TLH, TLF: Applied voltage: 500 : 250 Duration: 60 s	VDC (TLF9UB)	ept TLF9UB))							
9. Withstanding : between wires									
CM-RA/BU-RA Type CM-RB Type	No abnormali	tv							
TLH, TLF Type	INO ADMONINAN	• 7							
Test method and remarks									
	: 2000VAC (TLH, T : 500VDC (TLF9UE	LF (except TLF9UB))							
Duration	: 60sec.								

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

TILLIN BILLIT I BILLIT					
10 Withsteading between wires and a					
10. Withstanding: between wires and c	OFE				
CM-RA/BU-RA Type					
CM-RB Type					
TLH, TLF Type	No abnormality				
[Test method and remarks]					
TLH, TLF : Applied voltage : 2000VA					
	C (TLF9UB)				
Duration : 60sec.					
11. Rated voltage					
	T				
CM-RA/BU-RA Type					
CM-RB Type	Within the specified range				
TLH, TLF Type					
Test method and remarks					
TLH, TLF (except TLF9UB) : 250VAC					
TLF9UB : 50VDC					
12. Resistance to vibration					
CM-RA/BU-RA Type					
CM-RB Type	Appearance : No abnormality Inductance change : Within ±15%				
TLH, TLF Type	TLF9U : Inductance change : Within ±5% TLH, TLF (except TLF9U) : Within the specified range				
Test method and remarks	TET 90 : Inductative strange : Within 20%				
	40				
CM, TLH, TLF : According to JIS C 0040 Direction : 2hrs each in X, Y and Z direction Total : 6hrs					
Frequency range : 10 to 55 to 10Hz					
	(r min.) exceed acceleration 196m/s²)				
Mounting method : soldering onto Po					
	overy under the standard condition after the test. (CM-RB)				
	covery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. (TLH, TLF)				
	,				
13. Solderability					
CM-RA/BU-RA Type					
	At least 75% of terminal electrode is covered by new solder.				
CM-RB Type					
TLH, TLF Type	Solder shall be uniformly adhered onto immersed surfaces.				
Test method and remarks					
CM : Solder temperature : 235					
	0.5sec.				
Immersion depth : Acc	cording to detailed specification.				
TLH, TLF: Solder temperature: 245					
Duration : 4±					
Immersion depth : Up	to 1.0 to 1.5mm from PBC mounted level.				
14. Resistance to soldering heat					
14. Resistance to soldering heat CM-RA/BU-RA Type	Annessance i Ne charmeliti.				
	Appearance : No abnormality Inductance change : Refer to individual specification				
CM-RA/BU-RA Type CM-RB Type					
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type	Appearance : No abnormality Inductance change : Refer to individual specification TLF9UA : Inductance change : Within ±5% TLF14CB : Within the specified range				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks]	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260: Duration : 5±0	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C 0.5sec.				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260: Duration : 5±0 Immersion depth : Up t	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C 1.5sec. 1.5cec. 2~2.5mm from terminal root.				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260: Duration : 5±0 Immersion depth : Up t	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C 0.5sec.				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C 1.5sec. 1.5ce. 1.5				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260: Duration : 5±0 Immersion depth : Up t Recovery : 1 to TLH, TLF : Solder temperature: 260: Duration : 10±	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. 0 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec.				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260: Duration : 5±0 Immersion depth : Up t Recovery : 1 to TLH, TLF : Solder temperature: 260: Duration : 10± Immersion depth : Up t	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C :1sec. o 1.0 to 1.5mm from PBC mounted level.				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260: Duration : 5±0 Immersion depth : Up t Recovery : 1 to TLH, TLF : Solder temperature: 260: Duration : 10± Immersion depth : Up t	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. 0 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec.				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260: Duration : 5±0 Immersion depth : Up t Recovery : 1 to TLH, TLF : Solder temperature: 260: Duration : 10± Immersion depth : Up t	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C :1sec. o 1.0 to 1.5mm from PBC mounted level.				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C :1sec. o 1.0 to 1.5mm from PBC mounted level.				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .0.5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. o 1.0 to 1.5mm from PBC mounted level				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C :1sec. o 1.0 to 1.5mm from PBC mounted level.				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. o 1.0 to 1.5mm from PBC mounted level. asst 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. o 1.0 to 1.5mm from PBC mounted level. asst 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15%				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. o 1.0 to 1.5mm from PBC mounted level. asst 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15%				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. o 1.0 to 1.5mm from PBC mounted level. asst 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15%				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. o 1.0 to 1.5mm from PBC mounted level. asst 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15%				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. o 1.0 to 1.5mm from PBC mounted level. asst 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15%				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. o 1.0 to 1.5mm from PBC mounted level. east 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15% TLH, TLF (except TLF9UA): Withstanding voltage: No abnormality Insulation resistance: No abnormality				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. 0 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. 0 1.0 to 1.5mm from PBC mounted level. east 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15% TLH, TLF (except TLF9UA): Withstanding voltage: No abnormality Insulation resistance: No abnormality				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. 0 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. 0 1.0 to 1.5mm from PBC mounted level. east 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15% TLH, TLF (except TLF9UA): Withstanding voltage: No abnormality Insulation resistance: No abnormality Durration (min) 30±3				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. o 1.0 to 1.5mm from PBC mounted level. sast 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. o 1.0 to 1.5mm from PBC mounted level. sast 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. o 1.0 to 1.5mm from PBC mounted level. sast 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec0 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec0 1.0 to 1.5mm from PBC mounted levelasst 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15% TLH, TLF (except TLF9UA): Withstanding voltage: No abnormality Insulation resistance: No abnormality Durration (min) 30±3 Within 3 30±3 Within 3 Within 3				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec. o 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. o 1.0 to 1.5mm from PBC mounted level. sast 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec0 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec0 1.0 to 1.5mm from PBC mounted levelasst 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15% TLH, TLF (except TLF9UA): Withstanding voltage: No abnormality Insulation resistance: No abnormality Durration (min) 30±3 Within 3 30±3 Within 3 Within 3				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec0 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec0 1.0 to 1.5mm from PBC mounted levelasst 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15% TLH, TLF (except TLF9UA): Withstanding voltage: No abnormality Insulation resistance: No abnormality Durration (min) 30±3 Within 3 30±3 Within 3 Within 3				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec0 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec0 1.0 to 1.5mm from PBC mounted levelasst 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15% TLH, TLF (except TLF9UA): Withstanding voltage: No abnormality Insulation resistance: No abnormality Durration (min) 30±3 Within 3 30±3 Within 3 Within 3				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .5sec0 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec0 1.0 to 1.5mm from PBC mounted levelasst 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15% TLH, TLF (except TLF9UA): Withstanding voltage: No abnormality Insulation resistance: No abnormality Durration (min) 30±3 Within 3 30±3 Within 3 Within 3				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .)Sesc. 0 2=2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. 0 1.0 to 1.5mm from PBC mounted level. sast 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C Sec. 0 2-2-5.mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C 1sec. 0 1.0 to 1.5mm from PBC mounted level. asst 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15% TLH, TLF (except TLF9UA): Withstanding voltage: No abnormality Insulation resistance: No abnormality Durration (min) 30±3 Within 3 30±3 Within 3 Sovery under the standard condition after the removal from test chamber, followed by the measurement within 2 hrs.				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C .)Sesc. 0 2=2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C .1sec. 0 1.0 to 1.5mm from PBC mounted level. sast 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C Sec. 0 2-2-5.mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C 1sec. 0 1.0 to 1.5mm from PBC mounted level. asst 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15% TLH, TLF (except TLF9UA): Withstanding voltage: No abnormality Insulation resistance: No abnormality Durration (min) 30±3 Within 3 30±3 Within 3 Sovery under the standard condition after the removal from test chamber, followed by the measurement within 2 hrs.				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	### TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ###################################				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C 1.5sec. 0 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C 1.5sec. 0 1.0 to 1.5mm from PBC mounted level. 1.5set 1.5 thr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15% TLH, TLF (except TLF9UA): Withstanding voltage: No abnormality Insulation resistance: No abnormality Durration (min) 30±3 Within 3 30±3 Within 3 30±3 Within 3 TLF9UA: Inductance change: Within ±15% TLF9UA: Inductance change: Wit				
CM-RA/BU-RA Type CM-RB Type TLH, TLF Type [Test method and remarks] CM : Solder temperature: 260:	TLF9UA: Inductance change: Within ±5% TLF14CB: Within the specified range ±5°C 1.5sec. 0 2~2.5mm from terminal root. 2 hrs of recovery under the standard condition after the test. ±5°C 1.5sec. 0 1.0 to 1.5mm from PBC mounted level. 1.5set 1.5 thr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. Appearance: No abnormality Inductance change: Refer to individual specification TLF9UA: Inductance change: Within ±15% TLH, TLF (except TLF9UA): Withstanding voltage: No abnormality Insulation resistance: No abnormality Durration (min) 30±3 Within 3 30±3 Within 3 30±3 Within 3 TLF9UA: Inductance change: Within ±15% TLF9UA: Inductance change: Wit				

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

RELIABILITY DATA							
17. Loading under damp heat							
Th. Exacting under damp fleet. CM-RA/BU-RA Type							
CM-RB Type	Appearance: No abnormality	Inductance change: Refer to individual specification					
TLH, TLF Type Withstanding voltage: No abnormality		Insulation resistance : No abnormality					
Test method and remarks	,	· · · · · · · · · · · · · · · · · · ·					
CM : Temperature : 40±2°C Humidity : 90~95%RH Duration : 500 (+12, -0) hrs Applied current : Rated current Recovery : 1 to 2hrs of recovery under the standard condition after the removal from test chamber.							
TLH, TLF: Temperature : 60±2°C							
Recovery : At least	t 1hr of recovery under the standard removal	from test chamber followed by the measurement within 2 hrs.					
40.1							
18. Low temperature life test							
CM-RA/BU-RA Type	Appearance: No abnormality	Inductance change: Refer to individual specification					
CM-RB Type	TLF9U : Inductance change : Within ±15%						
TLH, TLF Type TLF9U : Inductance change : Within ±15% TLH, TLF (except TLF9U) : Withstanding voltage : No abnormality Insulation resistance : No abno							
Test method and remarks CM : Temperature : -40±3°C							
19. High Temperature life test							
CM-RA/BU-RA Type CM-RB Type	Appearance : No abnormality	Inductance change : Refer to individual specification					
TLH, TLF Type TLH, TLF (except TLF9U): Withstanding v							
	O) hrs f recovery under the standard condition after f recovery under the standard condition after	the removal from test chamber. (CM-RA)					
Recovery : At least 1h	r of recovery under the standard removal from	test chamber followed by the measurement within 2 hrs.					

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

CM-RA Type, CM-RB Type, TLH, TLF Type

1. Circuit Design

Precautions

Operating environment

1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems) where product failure might result in loss of life, injury or damage. For such uses, contact TAÍYO YUDEN Sales Department in advance.

2. PCB Design

Precautions

Design 1. Please design insertion pitches as matching to that of leads of the component on PCBs.

Technical considerations

Design

1. When Inductors are mounted onto a PC board, hole dimensions on the board should match the lead pitch of the component, if not, it will cause breakage of the terminals or cracking of terminal roots covered with resin as excess stress travels through the terminal legs

3. Soldering

Wave soldering

- Please refer to the specifications in the catalog for a wave soldering.
- 2. Do not immerse the entire inductor in the flux during the soldering operation.

Lead free soldering

Precautions

- 1. When using products with lead free soldering, we request to use them after confirming of adhesion, temperature of resistance to soldering heat, etc. sufficiently.
- ◆Recommended conditions for using a soldering iron
- Put the soldering iron on the land-pattern.
 Soldering iron's temperature Below 350°C
- · Duration 3 seconds or less
- The soldering iron should not directly touch the product

Technical considerations

◆Lead free soldering

1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

4. Cleaning

Precautions

Cleaning conditions1. TLF type

Please contact any of our offices for about a cleaning.

5. Handling

Precautions

Handling

1. Keep the product away from all magnets and magnetic objects.

Mechanical considerations

1. Please do not give the product any excessive mechanical shocks.

2. TLF type

Please do not add any shock or power to a product in transportation.

◆Packing

1. Please do not give the product any excessive mechanical shocks.

In loading, please pay attention to handling indication mentioned in a packing box (a loading direction / number of maximum loading / fragile item).

◆Handling

There is a case that a characteristic varies with magnetic influence.

Technical considerations

 Mechanical considerations 1. There is a case to be damaged by a mechanical shock.

2. TLF type

There is a case to be broken by a fall.

1. There is a case that a lead route turns at by a fall or an excessive shock

6. Storage conditions

◆Storage

1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.

Precautions

· Recommended conditions Ambient temperature: 0~40°C

Humidity : Below 70% RH

The ambient temperature must be kept below 30°C. Even under ideal storage conditions, the solderbility of electrodes decreases gradually, so the products should be mounted within one year from the time of delivery.

In case of storage over 6 months, solderability shall be checked before actual usage.

Technical considerations

◆Storage

1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place

^{*} This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs